Hongkong Post to hold exhibition for 17th Inter-School Stamp Exhibits Competition (with photo)

Hongkong Post announced today (June 14) that an exhibition displaying the winning entries and other entries of the 17th Inter-School Stamp Exhibits Competition will be held at Sha Tin Town Hall from June 29 to July 1. The competition is co-organised by Hongkong Post and the Education Bureau to promote philately among students. The exhibition will be open to the public and admission is free.

Hongkong Post will issue a souvenir cover, together with a special postmark and a cachet, to mark the event. Souvenir covers will be put on sale at \$2 each at all philatelic offices from tomorrow (June 15) to July 1. A hand-back date-stamping service will be provided at the exhibition venue and all philatelic offices on June 29.

Information about the exhibition and the souvenir covers is available on Hongkong Post's website at www.hongkongpost.hk and the Hongkong Post mobile app.

